



Product Change Notification

Change Notification #: 116866 - 00
Change Title: Select Intel® Platform Hubs,
 PCN 116866-00, Manufacturing Site, Label,
 Notification to Customers for Addition of
 Vietnam as a Factory Assembly site
Date of Publication: March 26, 2019

Key Characteristics of the Change:
 Manufacturing Site, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 26, 2019
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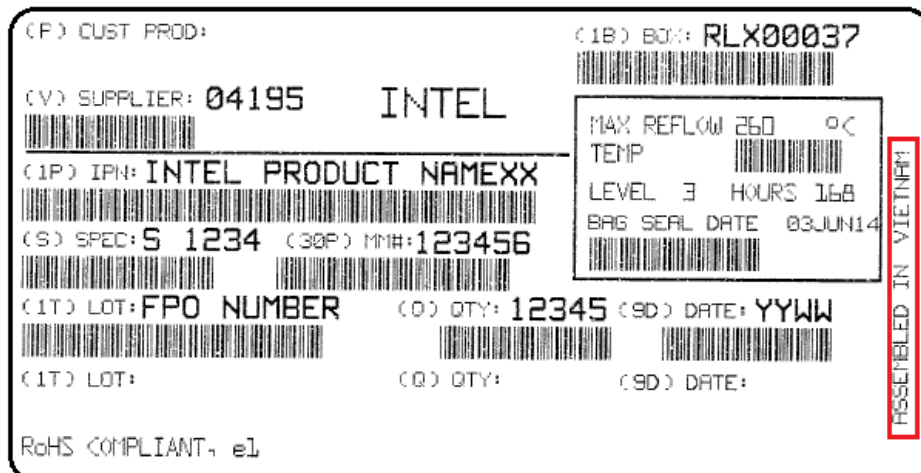
Description of Change to the Customer:

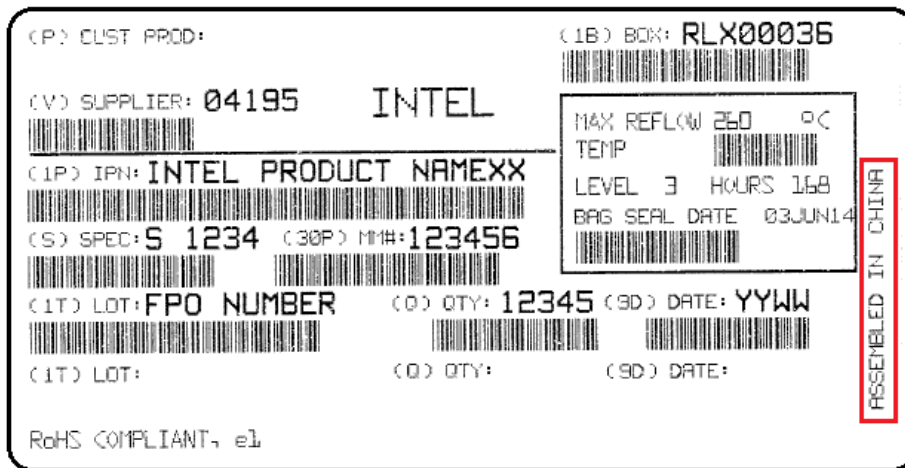
In order to ensure a continuous supply of the Intel® Platform Hubs listed in the "Products Affected" Table below. Intel will be adding Vietnam as a qualified site to perform portions of Assembly Manufacturing process. The Assembly process will be completed between Vietnam and China, with the Test and Finish Manufacturing process to remain the same as today in China for these products.

Both CDAT and VNAT sites have already been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

Please note that the Country of Origin (COO) value printed on box labels may change according to which Intel Manufacturing site performs the Assembly. The country of the specific Intel Manufacturing Site which starts the Assembly process will be country value that is displayed on Labels. Therefore, customers can expect to see either “China” or “Vietnam” printed on the box labels per label example below – This label is a representation for example purposes only. The actual label will reflect correct product data.

(Pictures for example only)





Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers for this change. Customers should notify their receiving department of the additional COO value to be printed on labels. It's possible that Customers may receive a mix of material assembled from either China or Vietnam. However, the remaining finished parts will come from China.

Please contact your Intel Field Sales Representative or the contacts listed on the last page of this Product Change Notification appropriate to your geography with questions.

Products Affected / Intel Ordering Codes:

Marketing Name	Platform	Product Code	S-Spec	MM#
Intel® BD82QM77 Platform Controller Hub	MOBILE	BD82QM77	S LJ8A	915663
Intel® BD82HM76 Platform Controller Hub	MOBILE	BD82HM76	S LJ8E	915666
Intel® BD82Q77 Platform Controller Hub	DESKTOP	BD82Q77	S LJ83	915673
Intel® BD82B75 Platform Controller Hub	DESKTOP	BD82B75	S LJ85	915675
Intel® BD82C216 Platform Controller Hub	SERVER	BD82C216	S LJ8H	915680

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
March 26, 2019	00	Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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